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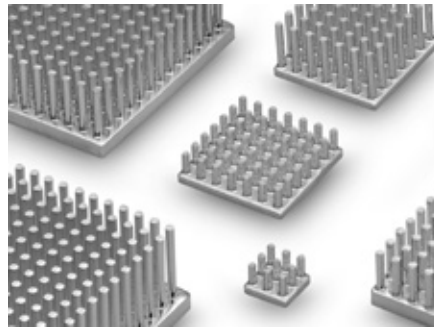
Product groups:

- Profile heatsinks and fluid coolers
- Heatsinks and active heatsinks for processors
- Finger-shaped heatsinks
- Cooling aggregates
- Accessories for electronic components

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Product group:

Heatsinks and active heatsinks for processors > Pin heatsinks

 Pin heatsinks / **ICK S 14 x 14 x 10**


14 x 14 x 10 mm, pin heatsinks quadratic

Parameters of article ICK S 14 x 14 x 10

Bauform	Rechteck
R_{th} [K/W]	9.8
dissipation loss [W]	5.1
mounting method	therm. conductive foil / therm. cond. adhesive
socket	universal
suitable for processor type	universal
width [mm]	14
height [mm]	10
plate thickness [mm]	2
weight [g]	1.9
length on stock [mm]	14

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